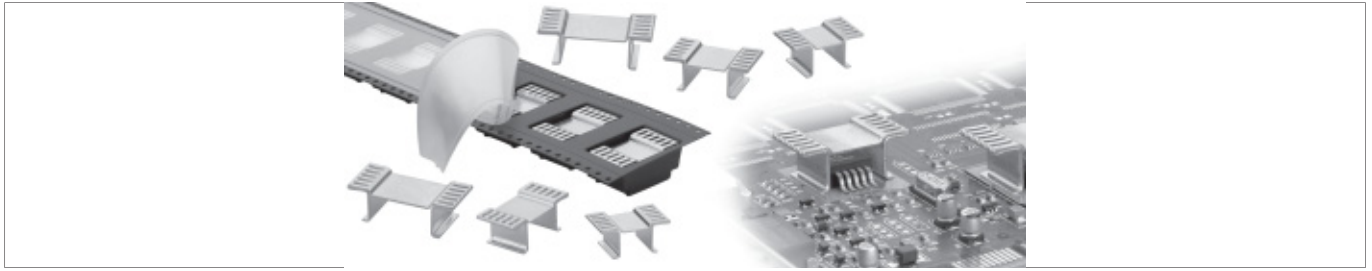


Heatsinks for D PAK and others



- copper heatsinks with excellent heat conductivity
- direct mounting on printed circuit through solderable surface
- especially suitable for SMD components of type D PAK (TO 252), D² PAK (TO 263), D³ PAK (TO 268), SOT 669 LF PAK, SO IC-8 FL MP, Power SO-8, Power SO-10, Power SO-20, Power SO-36, SO-14, SO-16, SOT 223 etc
- available standard packing: bulk parts or reel
- special packing like magazine, tray etc. on request; - special versions according to customers specifications
- **tape width:** 44 mm, **reel diameter:** 330 mm, **quantity:** FK 244 08 = 450, FK 244 13 = 200

art. no.			
FK 244 08 D PAK ... weight: 2g		31,5 K/W	
art. no.			
FK 244 13 D PAK ... weight: 3.3g		25 K/W	
art. no.			
FK 244 08 D2 PAK ... weight: 2.2g		29,3 K/W	
art. no.			
FK 244 13 D2 PAK ... weight: 3.6g		22,8 K/W	
art. no.			
FK 244 08 D3 PAK ... weight: 2.5g		26 K/W	
art. no.			
FK 244 13 D3 PAK ... weight: 3.9g		19,5 K/W	
please indicate:	... packing (optional) TR = tape and reel		
surface:	solderable surface		
material:	copper (Cu)		
material thickness:	0.6 mm		